HCV1206

High current power inductors



Product features

- · Flat-wire construction
- · Low DCR, high efficiency
- Secure 3 terminal mounting
- 12.7 mm x 10.15 mm footprint surface mount package in a 5.1 mm height
- · Ferrite core material

Applications

Compatible with Picor® Cool-Power®
 ZVS Buckand Buck-Boost Regulator Families
 (Picor part number series Pl37xx and Pl35xx)

Environmental data

- Storage temperature range (component): -55 °C to +125 °C
- Operating temperature range: -55 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020 (latest revision) compliant







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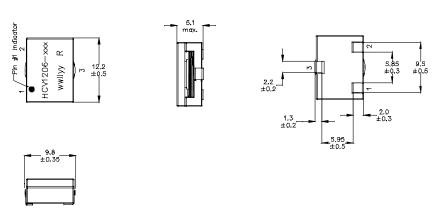


Product Specifications

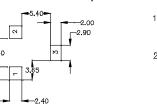
| Part Number ⁴ | OCL¹ (µH) ±10% | I _{rms²} (A) | l _{sat³} (A) | DCR (mΩ) @ +20 °C ±10% |
|--------------------------|-------------------|--------------------------|--------------------------|------------------------------|
| HCV1206-R42-R | 0.42 | 16 | 42 | 3.15 |
| HCV1206-R48-R | 0.48 | 16 | 37 | 3.15 |
| HCV1206-R90-R | 0.90 | 14 | 28 | 4.6 |
| HCV1206-1R0-R | 1.0 | 14 | 24.5 | 4.6 |
| HCV1206-1R5-R | 1.5 | 12 | 21 | 6.0 |
| HCV1206-2R0-R | 2.0 | 12 | 16 | 6.0 |
| HCV1206-3R0-R | 3.0 | 11 | 13 | 7.4 |

- 1. Open Circuit Inductance (OCL) Test Parameters: 100 kHz, 0.1 Vrms, 0.0 Adc, +25 °C
- 2. I_{ms}- DC current for an approximate temperature rise of 40 °C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed +125 °C under worst case operating conditions verified in the end application.
- 3. I_{sat}: Peak current for approximately 5% rolloff @ +25 °C
- 4. Part Number Definition: HCV1206-xxx-R HCV1206 = Product code and size xxx=Inductance value in μH, -R suffix = RoHS compliant

Dimensions- mm



Recommended Pad Layout



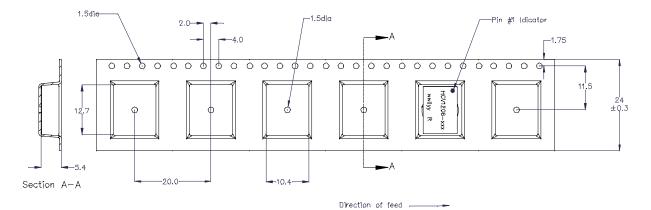
Schematic



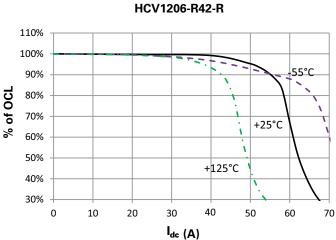
Part marking: HCV1206–xxx, xxx=inductance value in μ H, R=decimal point, wwllyy= date code, R=revision level Soldering surfaces to be coplanar within 0.1 millimeters Pin 3 is for mounting stability. No connection. Do not route traces or vias underneath the inductor.

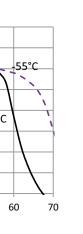
Packaging information- mm

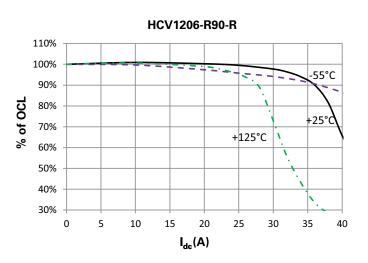
Supplied in tape and reel packaging, 550 parts per 13" diameter reel

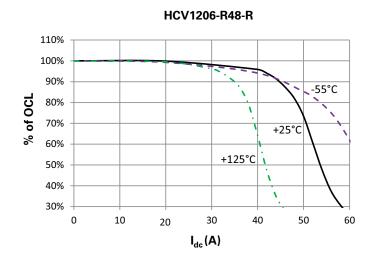


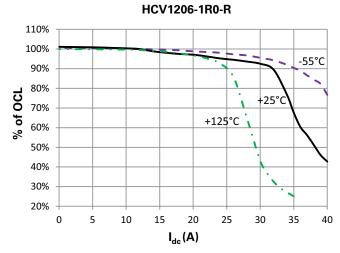
Inductance characteristics



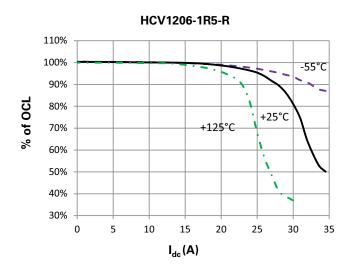


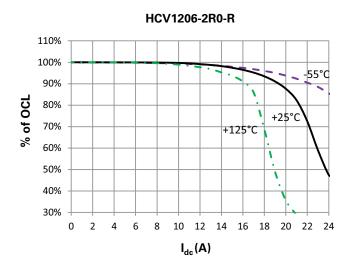


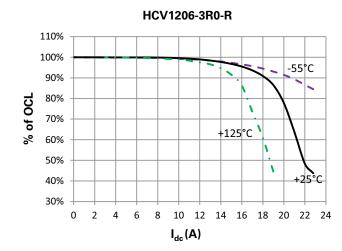




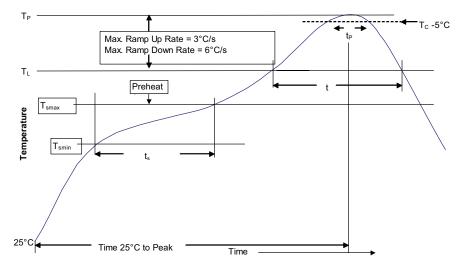
Inductance characteristics







Solder reflow profile



-_{Tc-5°C} Table 1 - Standard SnPb Solder (T_C)

| Package Thickness | Volume mm³ <350 | Volume mm³ ≥350 |
|----------------------|-----------------------|-----------------------|
| <2.5mm) | 235°C | 220°C |
| ≥2.5mm | 220°C | 220°C |

Table 2 - Lead (Pb) Free Solder (Tc)

| Package Thickness | Volume mm³ <350 | Volume mm³ 350 - 2000 | Volume mm³ >2000 |
|----------------------|-----------------------|-----------------------------|------------------------|
| <1.6mm | 260°C | 260°C | 260°C |
| 1.6 - 2.5mm | 260°C | 250°C | 245°C |
| >2.5mm | 250°C | 245°C | 245°C |

Reference JDEC J-STD-020

| Profile Feature | Standard SnPb Solder | Lead (Pb) Free Solder | |
|--|-------------------------|-------------------------|--|
| Preheat and Soak • Temperature min. (T _{smin}) | 100°C | 150°C | |
| • Temperature max. (T _{smax}) | 150°C | 200°C | |
| • Time (T _{smin} to T _{smax}) (t _s) | 60-120 Seconds | 60-120 Seconds | |
| Average ramp up rate T _{smax} to T _p | 3°C/ Second Max. | 3°C/ Second Max. | |
| Liquidous temperature (TL) Time at liquidous (tL) | 183°C 60-150 Seconds | 217°C 60-150 Seconds | |
| Peak package body temperature (Tp)* | Table 1 | Table 2 | |
| Time (t _p)** within 5 °C of the specified classification temperature (T _c) | 20 Seconds** | 30 Seconds** | |
| Average ramp-down rate (T _p to T _{smax}) | 6°C/ Second Max. | 6°C/ Second Max. | |
| Time 25°C to Peak Temperature | 6 Minutes Max. | 8 Minutes Max. | |

 $^{^{*}}$ Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

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